

Supplementary information for:

# Architected Cu–TNTZ Bilayered Coatings Showing Bacterial Inactivation under Indoor Light and Controllable Copper Release: Effect of the Microstructure on Copper Diffusion

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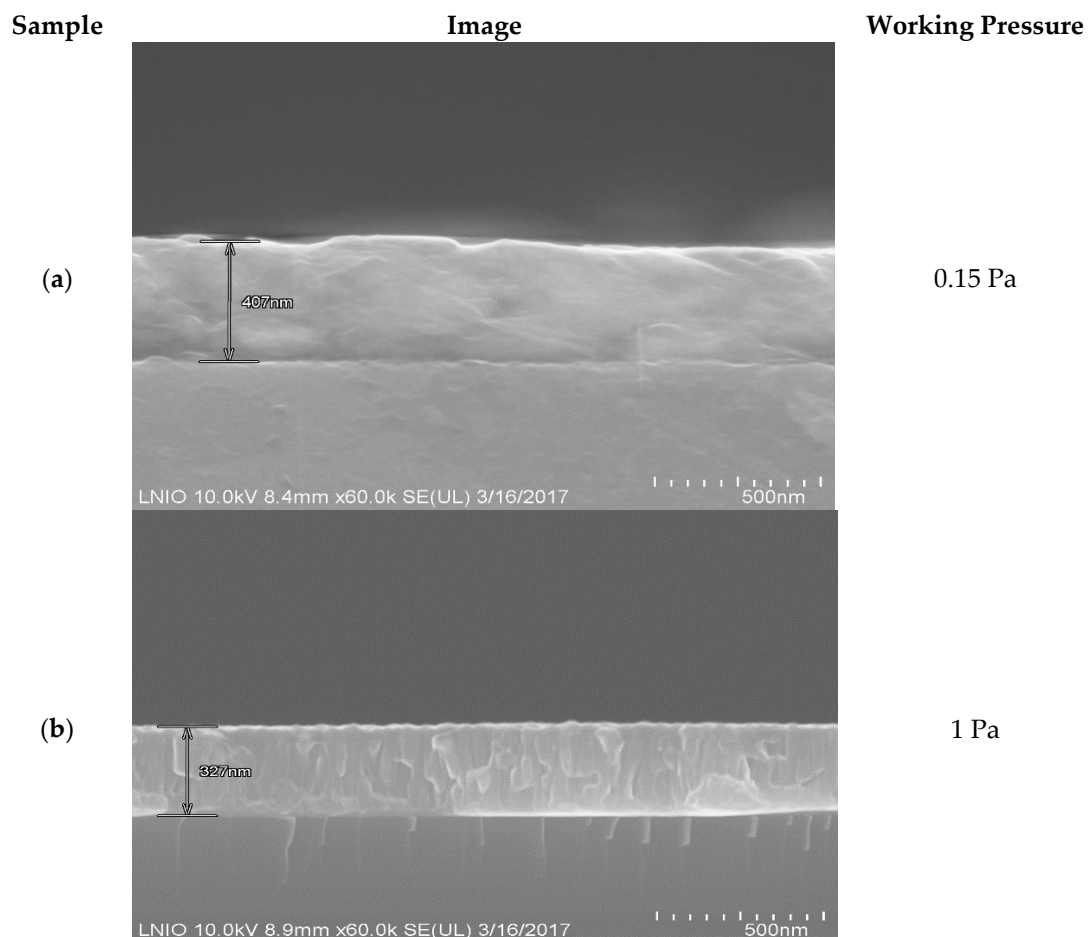
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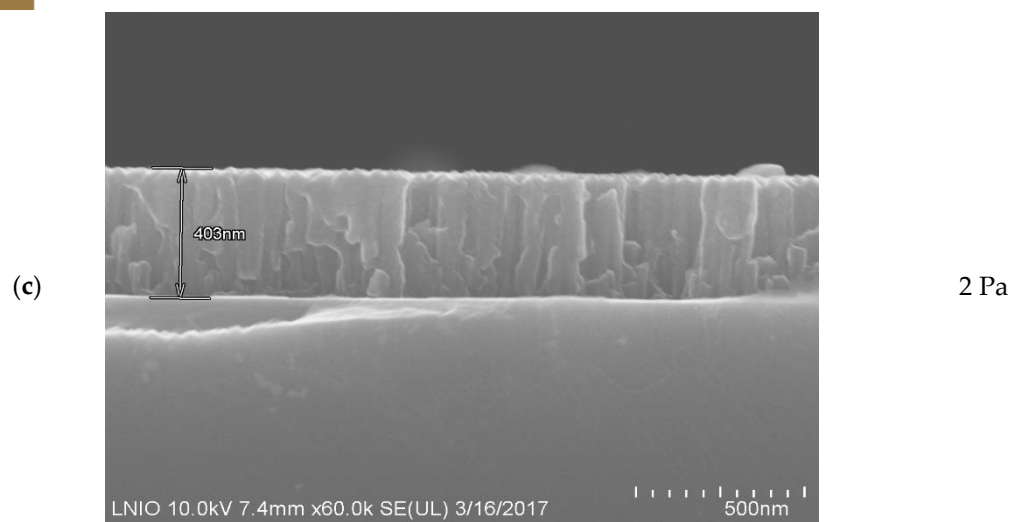
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**Figure 1.** SEM images of TNTZ coatings sputtered at different working pressures. (a) 0.15 Pa; (b) 1 Pa; (c) 2 Pa.